

ON Semiconductor®

FDS6570A

Single N-Channel 2.5V Specified PowerTrench® MOSFET

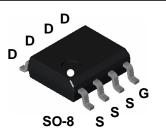
General Description

This N-Channel 2.5V specified MOSFET is produced using ON Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

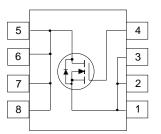
Applications

- DC/DC converter
- Load switch
- Battery protection



Features

- 15 A, 20 V. $R_{DS(on)} = 0.0075 \ \Omega \ @ V_{GS} = 4.5 \ V$ $R_{DS(on)} = 0.010 \ \Omega \ @ V_{GS} = 2.5 \ V.$
- Low gate charge (47nC typical).
- Fast switching speed.
- High performance trench technology for extremely low $R_{_{\mbox{DS}(\mbox{ON})}}$
- High power and current handling capability.



Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		FDS6570A	Units
V _{DSS}	Drain-Source Voltage		20	V
V _{GSS}	Gate-Source Voltage		<u>+</u> 8	V
ID	Drain Current - Continuous	(Note 1a)	15	А
	- Pulsed		50	
P _D	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.2	
		(Note 1c)	1	
T _J , T _{stg}	Operating and Storage Junction Temperature	re Range	-55 to +150	°C

Thermal Characteristics

R _{θJA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W
R _θ յc	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

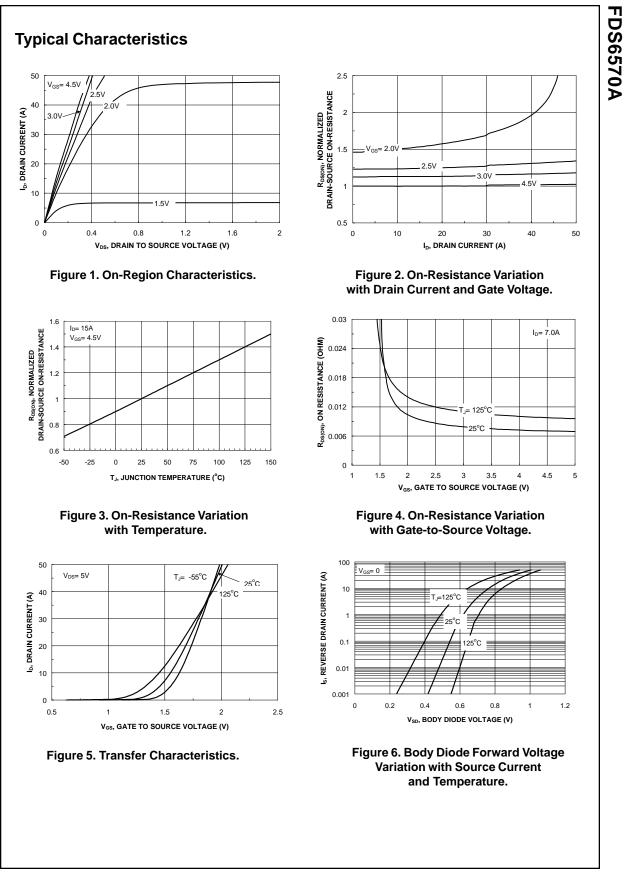
Package Outlines and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
FDS6570A	FDS6570A	13"	12mm	2500 units

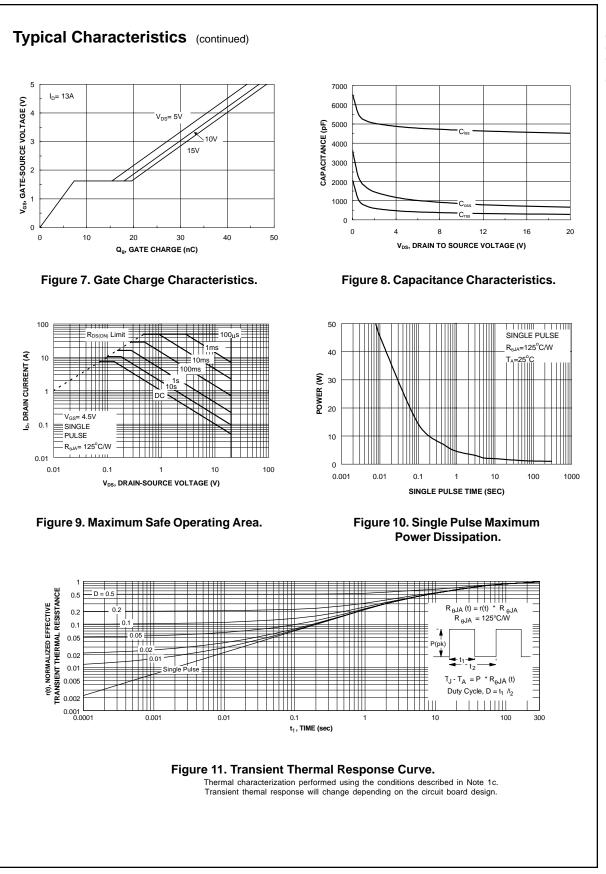
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eristics in-Source Breakdown Voltage akdown Voltage Temperature officient o Gate Voltage Drain Current	$V_{GS} = 0 V$, $I_D = 250 \mu A$ $I_D = 250 \mu A$, Referenced to 25°C	20	29		
akdown Voltage Temperature	$I_D = 250\mu A$, Referenced to $25^{\circ}C$	20	29		
fficient			29		V
o Gate Voltage Drain Current			20		mV/°C
	$V_{DS} = 16 V, V_{GS} = 0 V$			1	μA
e-Body Leakage Current, Forward	$V_{GS} = 8 V, V_{DS} = 0 V$			100	nA
e-Body Leakage Current, Reverse	V_{GS} = -8 V, V_{DS} = 0 V			-100	nA
ristics (Note 2)					
e Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	0.4	0.9	1.5	V
e Threshold Voltage	I_D = 250µA, Referenced to 25°C		-4		mV/°C
tic Drain-Source Resistance	$V_{GS} = 4.5 V, I_D = 15 A$ $V_{GS} = 4.5 V, I_D = 15 A,$ $T_J=125^{\circ}C$ $V_{GS} = 2.5 V, I_D = 12 A$		0.006 0.009 0.008	0.0075 0.0130 0.0100	Ω
State Drain Current	$V_{GS} = 4.5 \text{ V}, V_{DS} = 5.0 \text{ V}$	25			А
ward Transconductance	$V_{DS} = 5 V, I_D = 15 A$		70		S
aracteristics					
ut Capacitance	V _{DS} = 10 V, V _{GS} = 0 V, f = 1.0 MHz		4700		pF
put Capacitance			850		pF
erse Transfer Capacitance			310		pF
haracteristics (Note 2)					
n-On Delay Time	$V_{DD} = 10 V, I_D = 1 A,$		20	32	ns
n-On Rise Time	V_{GS} = 4.5 V, R_{GEN} = 6 Ω		27	44	ns
n-Off Delay Time			95	133	ns
n-Off Fall Time			35	56	ns
al Gate Charge	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 15 \text{ A},$		47	66	nC
e-Source Charge	V _{GS} = 5 V,		7		nC
e-Drain Charge			10.5		nC
e Diode Characteristics an	d Maximum Ratings				
				2.1	А
in-Source Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)		0.65	1.2	V
	ristics (Note 2) e Threshold Voltage e Threshold Voltage perature Coefficient ic Drain-Source Resistance State Drain Current ward Transconductance aracteristics it Capacitance out Capacitance erse Transfer Capacitance haracteristics (Note 2) n-On Delay Time n-Off Delay Time n-Off Fall Time al Gate Charge e-Source Charge e-Drain Charge e Diode Characteristics an Maximum Continuous Drain-Sou n-Source Diode Forward Voltage f the junction-to-case and case-to-ambient re	ristics(Note 2)e Threshold Voltage $V_{DS} = V_{GS}$, $I_D = 250 \mu$ Ae Threshold Voltage $I_D = 250 \mu$ A, Referenced to 25°Ca Threshold Voltage $I_D = 250 \mu$ A, Referenced to 25°Ca perature Coefficient $I_D = 250 \mu$ A, Referenced to 25°Cic Drain-Source $V_{GS} = 4.5 V$, $I_D = 15 A$ Resistance $V_{GS} = 2.5 V$, $I_D = 15 A$,T_J=125°C $V_{GS} = 2.5 V$, $I_D = 12 A$ State Drain Current $V_{GS} = 4.5 V$, $V_{DS} = 5.0 V$ ward Transconductance $V_{DS} = 5 V$, $I_D = 15 A$ aracteristics $V_{DS} = 10 V$, $V_{GS} = 0 V$,tt Capacitance $V_{DS} = 10 V$, $V_{GS} = 0 V$,f = 1.0 MHz $I_D = 10 V$, $I_D = 1 A$,h-On Delay Time $V_{DD} = 10 V$, $I_D = 1 A$,h-On Rise Time $V_{DS} = 10 V$, $I_D = 15 A$,h-Off Fall Time $V_{GS} = 4.5 V$, $R_{GEN} = 6 \Omega$ h-Off Fall Time $V_{DS} = 10 V$, $I_D = 15 A$, $V_{GS} = 5 V$, $V_{GS} = 5 V$,e-Drain Charge $V_{DS} = 10 V$, $I_D = 15 A$, $V_{GS} = 5 V$, $V_{GS} = 5 V$,e-Drain Charge $V_{GS} = 0 V$, $I_S = 2.1 A (Note 2)$	ristics(Note 2)a Threshold Voltage $V_{DS} = V_{GS}, I_D = 250 \ \mu\text{A}$ 0.4a Threshold Voltage $I_D = 250 \ \mu\text{A}$ 0.4a Threshold Voltage $V_{GS} = 4.5 \ V, I_D = 15 \ A$ 0.4c Drain-Source $V_{GS} = 4.5 \ V, I_D = 15 \ A$ 0.4Resistance $V_{GS} = 2.5 \ V, I_D = 12 \ A$ 0.4State Drain Current $V_{GS} = 4.5 \ V, V_{DS} = 5.0 \ V$ 25ward Transconductance $V_{DS} = 5 \ V, I_D = 15 \ A$ 0.4aracteristicstt Capacitance $V_{DS} = 10 \ V, V_{GS} = 0 \ V, f = 1.0 \ MHz$ but Capacitance $V_{DS} = 10 \ V, I_D = 1 \ A, V_{GS} = 4.5 \ V, R_{GEN} = 6 \ \Omega$ h-On Rise Time $V_{CS} = 4.5 \ V, R_{GEN} = 6 \ \Omega$ h-On Rise Time $V_{DS} = 10 \ V, I_D = 15 \ A, V_{GS} = 5 \ V, R_{GS} = 0 \ V, I_S = 2.1 \ A \ (Note 2)$ the junction-to-case and case-to-ambient resistance where the case thermal reference is defined a	ristics (Note 2)a Threshold Voltage $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ 0.4 0.9 a Threshold Voltage $I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$ -4 apperature Coefficient $I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$ -4 ic Drain-Source $V_{GS} = 4.5 \ V, I_D = 15 \ A$ 0.006 Resistance $V_{GS} = 4.5 \ V, I_D = 15 \ A$ 0.008 $V_{GS} = 2.5 \ V, I_D = 12 \ A$ $V_{GS} = 2.5 \ V, I_D = 12 \ A$ 0.008 State Drain Current $V_{GS} = 4.5 \ V, V_{DS} = 5.0 \ V$ 25 ward Transconductance $V_{DS} = 5 \ V, I_D = 15 \ A$ 70 aracteristics $V_{DS} = 10 \ V, V_{GS} = 0 \ V, f = 1.0 \ MHz$ 850 aracteristics $(Note 2)$ $10 \ MHz$ 850 but Capacitance $V_{DS} = 10 \ V, I_D = 1 \ A, V_{GS} = 4.5 \ V, R_{GEN} = 6 \ \Omega$ 27 $-On Delay TimeV_{DD} = 10 \ V, I_D = 15 \ A, V_{GS} = 5 \ V, R_{GEN} = 6 \ \Omega27-Off Delay TimeV_{DS} = 10 \ V, I_D = 15 \ A, V_{GS} = 5 \ V, R_{GS} = 0 \ V, I_S = 2.1 \ A \ (Note 2)0.65Maximum Continuous Drain-Source Diode Forward Currentn-Source Diode Forward VoltageV_{GS} = 0 \ V, I_S = 2.1 \ A \ (Note 2)0.65$	ristics (Note 2)e Threshold Voltage $V_{DS} = V_{GS}$, $I_D = 250 \ \mu$ A 0.4 0.9 1.5 e Threshold Voltage $I_D = 250 \ \mu$ A, Referenced to 25° C -4 -4 pperature Coefficient $I_D = 250 \ \mu$ A, Referenced to 25° C -4 is Drain-Source $V_{GS} = 4.5 \ V$, $I_D = 15 \ A$, $V_{GS} = 4.5 \ V$, $I_D = 15 \ A$, $T_J = 125^{\circ}$ C $0.006 \ 0.0075$ Resistance $V_{GS} = 4.5 \ V$, $I_D = 15 \ A$, $V_{GS} = 2.5 \ V$, $I_D = 12 \ A$ $0.008 \ 0.0100$ State Drain Current $V_{GS} = 4.5 \ V$, $V_{DS} = 5.0 \ V$ 25 ward Transconductance $V_{DS} = 5 \ V$, $I_D = 15 \ A$ 70 aracteristics T T 850 erse Transfer Capacitance $f = 1.0 \ MHz$ 850 erse Transfer Capacitance $V_{DS} = 10 \ V$, $I_D = 1 \ A$, $V_{GS} = 4.5 \ V$, $R_{GEN} = 6 \ \Omega$ $27 \ 44$ -On Delay Time $V_{DS} = 10 \ V$, $I_D = 15 \ A$, $V_{GS} = 4.5 \ V$, $R_{GEN} = 6 \ \Omega$ $27 \ 44$ -Off Delay Time $95 \ 133$ $35 \ 56$ al Gate Charge $V_{DS} = 10 \ V$, $I_D = 15 \ A$, $V_{GS} = 5 \ V$, $77 \ -27 \ 44$ -Off Fall Time $10.5 \ -27 \ 74$ al Gate Charge $V_{DS} = 5 \ V$, $77 \ -27 \ -27 \ 74$ e-Drain Charge $V_{DS} = 10 \ V$, $I_D = 15 \ A$, $V_{GS} = 5 \ V$, $77 \ -27 \ -27 \ 74 \ 766 \ -25 \ 77 \ 77 \ -27 \ 77 \ -27 \ 77 \ 77 \ $

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